

Product Technical Data Sheet

Termosonik PCB

The preparation is a harmless, non-flammable, water-based agent. It is used to quickly remove all types of fluxing agents, solder pastes, and SMT adhesives, as well as other impurities arising from the soldering process from stencils and printed circuit boards. Product directly for use - DO NOT THIN.

Mix thoroughly before use.

Instructions for use:

Pour the liquid directly into the ultrasonic cleaner. Clean with ultrasounds for at least 10 minutes. Remove the plate and thoroughly rinse under running water. ! It is advisable to rinse the plate first under tap water, followed by demineralised or deionized water to remove any residue. Allow to dry at room temperature or dry with a hot air stream.

Application:

- liquid for ultrasonic cleaners.

Physicochemical properties of the liquid:

Parameters	UoM	Result
Appearance	-	colourless liquid
Density	g/cm ³	0,991
pH	-	11

Packagings:

Volume	Type of packaging	Collective packaging	Item Code
1 L	plastic bottle	1	ART.AGT-200

Warehousing:

Store in a well-ventilated, cool place. Keep away from children. Avoid sources of ignition, heat, hot surfaces and open flames.

Data contained in this document are consistent with the current state of our knowledge. They describe typical product properties and applications. However, it is up to the user to examine the suitability of this product for specific applications. We deny liability for the obtained results on the grounds that application conditions lie beyond our control.